

In the Claims:

1-9. (Cancelled).

10. (Previously Presented) The device of claim 13, further including a circulation pump integrated into the heat transfer medium circuit to convey a liquid heat transfer medium through the heat exchanger and at least the first heating/cooling surface.

11. (Cancelled).

12. (Previously Presented) The device of claims 13, further including a second evaporator integrated into the coolant circuit and through which air flows.

13. (Currently Amended) A device for climate control of a vehicle interior, comprising:

a coolant circuit including a compressor, a condenser, and an evaporator;

a heat transfer medium circuit including a heat source and a first heat exchanger;

a heat/cold reservoir in which the evaporator and the first heat exchanger are located;

and

a first heating/cooling surface integrated in the heat transfer medium circuit and being connected in parallel to the first heat exchanger;

a second heating/cooling surface heat exchanger integrated in the heat transfer medium circuit and being connected in parallel to the first heating/cooling surface;

means for selectively fluid conductively connecting the first heating/cooling surface with the first heat exchanger, which means for fluid conductively connecting have a connecting and a non-connecting state;

means for selectively fluid conductively connecting the second heating/cooling surface heat exchanger with the first heat exchanger, which means for fluid conductively connecting the second heat exchanger have a connecting and a non-connecting state;

means for selectively fluid conductively connecting the first heating/cooling surface with the heat source, which means for fluid conductively connecting the heating/cooling surface have a connecting and a non-connecting state;

means for selectively fluid conductively connecting the second heating/cooling surface heat exchanger with the heat source, which means for fluid conductively connecting the second heat exchanger with the heat source have a connecting and a non-connecting state; and

a circulation pump integrated in the heat transfer medium circuit, which circulation pump is arranged for pumping at least part of said heat transfer medium, coming directly from said heat source, through said first heat exchanger.